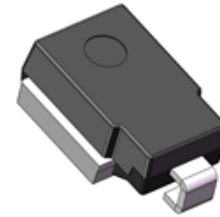


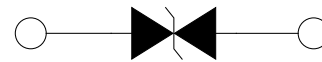
Automotive Protection Surface Mount Transient Voltage Suppressors

Features

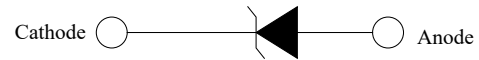
- Chip produced by chemical method
- Junction passivated by high temperature resistant insulating adhesive
- $T_J = 175\text{ }^{\circ}\text{C}$ capability suitable for high reliability and automotive requirement
- Low leakage current
- Low forward voltage drop
- High surge capability
- Meets ISO 16750-2 surge specification (varied by test condition)
- LF maximum peak of $245\text{ }^{\circ}\text{C}$
- AEC-Q101 qualified



DO-218AB



Bi-directional



Uni-directional

Mechanical Data

Case: DO-218AB

Molding compound meets UL 94 V-0 flammability rating Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified ("X" denotes revision code e.g. A, B, ...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

Polarity: heatsink is anode

Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Peak pulse power dissipation	with 10/1000 μs waveform	P_{PPM}	4600	W
	with 10/10 000 μs waveform		3600	
Power dissipation on infinite heatsink at $T_C = 25\text{ }^{\circ}\text{C}$ (fig. 1)		P_D	6.0	W
Peak pulse current with 10/1000 μs waveform		$I_{PPM}^{(1)}$	See next table	A
Peak forward surge current 8.3 ms single half sine-wave		I_{FSM}	600	A
Operating junction and storage temperature range		T_J, T_{STG}	-55 to +175	$^{\circ}\text{C}$

Note

(1) Non-repetitive current pulse derated above $T_A = 25\text{ }^{\circ}\text{C}$

Thermal Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Typical thermal resistance, junction to case	$R_{\theta JC}$	0.95	$^{\circ}\text{C/W}$

Ordering Information (Example)

Part Number	Unit Weight (g)	Package	Quantity	Delivery Mode
SM6S Series	2.85	DO-218AB	750 pcs	According to customer's requirement



Ratings and Characteristics Curves ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

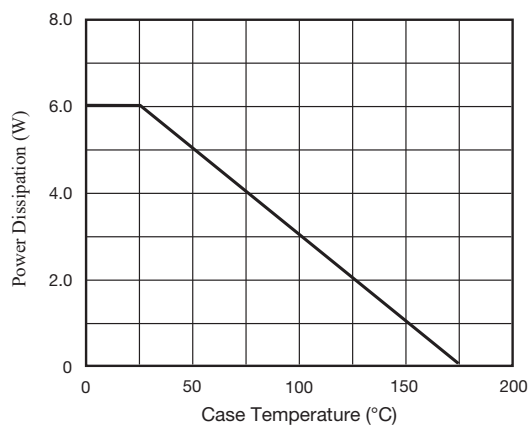


Fig. 1 - Power Derating Curve

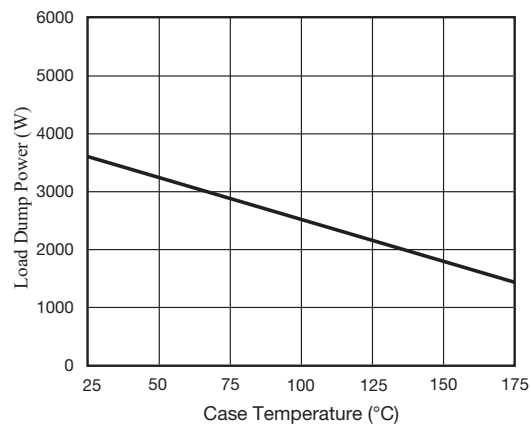


Fig. 2 - Load Dump Power Characteristics (10 ms Exponential Waveform)

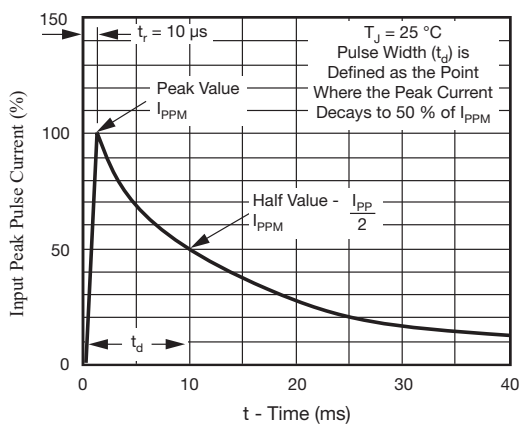


Fig. 3 - Pulse Waveform

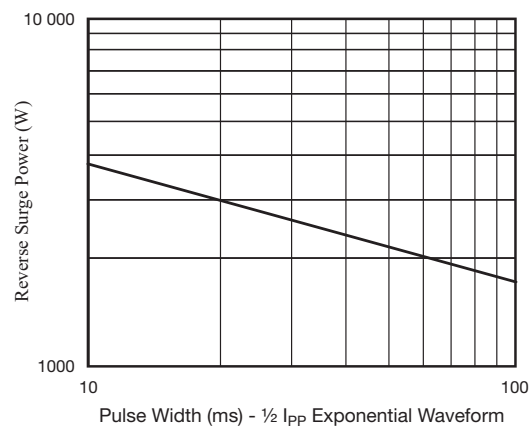


Fig. 4 - Reverse Power Capability

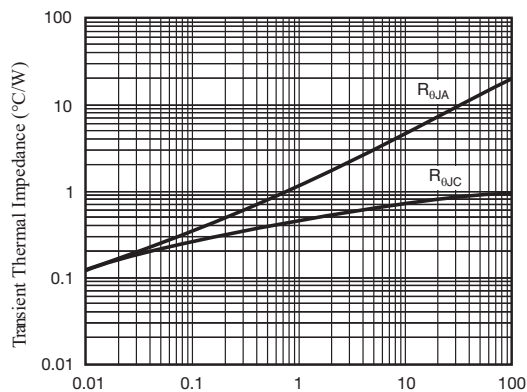


Fig. 5 - Typical Transient Thermal Impedance



Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Part Number		Breakdown Voltage V_{BR} (V)			Test Current I_T (mA)	Stand-off Voltage V_{RWM} (V)	Reverse Leakage I_R @ V_{RWM} (μA)	Reverse Leakage I_R @ V_{RWM} $T_J=175^{\circ}\text{C}$ (μA)	Reverse Surge Current I_{PP} (A)	Clamping Voltage V_C @ I_{PP} (V)	Coefficient OF V_{BR} αT (%/°C)
Uni	Bi	Min.	Nom.	Max.							
SM6S10A	SM6S10CA	11.1	11.7	12.3	5.0	10.0	10	150	271	17.0	0.069
SM6S11A	SM6S11CA	12.2	12.9	13.5	5.0	11.0	10	150	253	18.2	0.072
SM6S12A	SM6S12CA	13.3	14.0	14.7	5.0	12.0	10	150	231	19.9	0.074
SM6S13A	SM6S13CA	14.4	15.2	15.9	5.0	13.0	10	150	214	21.5	0.076
SM6S14A	SM6S14CA	15.6	16.4	17.2	5.0	14.0	10	150	198	23.2	0.078
SM6S15A	SM6S15CA	16.7	17.6	18.5	5.0	15.0	10	150	189	24.4	0.080
SM6S16A	SM6S16CA	17.8	18.8	19.7	5.0	16.0	10	150	177	26.0	0.081
SM6S17A	SM6S17CA	18.9	19.9	20.9	5.0	17.0	10	150	167	27.6	0.082
SM6S18A	SM6S18CA	20.0	21.1	22.1	5.0	18.0	10	150	158	29.2	0.083
SM6S20A	SM6S20CA	22.2	23.4	24.5	5.0	20.0	10	150	142	32.4	0.085
SM6S22A	SM6S22CA	24.4	25.7	26.9	5.0	22.0	10	150	130	35.5	0.086
SM6S24A	SM6S24CA	26.7	28.1	29.5	5.0	24.0	10	150	118	38.9	0.087
SM6S26A	SM6S26CA	28.9	30.4	31.9	5.0	26.0	10	150	109	42.1	0.088
SM6S28A	SM6S28CA	31.1	32.8	34.4	5.0	28.0	10	150	101	45.4	0.089
SM6S30A	SM6S30CA	33.3	35.1	36.8	5.0	30.0	10	150	95	48.4	0.090
SM6S33A	SM6S33CA	36.7	38.7	40.6	5.0	33.0	10	150	86	53.3	0.091
SM6S36A	SM6S36CA	40.0	42.1	44.2	5.0	36.0	10	150	79	58.1	0.091
SM6S40A	SM6S40CA	44.4	46.8	49.1	5.0	40.0	10	150	71	64.5	0.092
SM6S43A	SM6S43CA	47.8	50.3	52.8	5.0	43.0	10	150	66	69.4	0.093

Notes

- For all types maximum $V_F = 1.9\text{ V}$ at $I_F = 100\text{ A}$ measured on 8.3 ms single half sine-wave or equivalent square wave, duty cycle = 4 pulses per minute maximum
- (1) To calculate V_{BR} vs. junction temperature, use the following formula: V_{BR} at $T_J = V_{BR}$ at $25^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25))$

Package Outline Dimensions (millimeters)

